

# **Excellent Integrated System Limited**

Stocking Distributor

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Vishay/Siliconix SIHP15N50E-GE3

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## Distributor of Vishay/Siliconix: Excellent Integrated System Limited

Datasheet of SIHP15N50E-GE3 - MOSFET N-CH 500V 14.5A TO-220AB

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#### SiHP15N50E

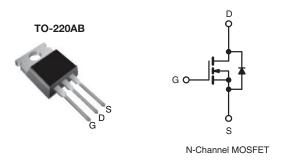
Vishay Siliconix

HALOGEN

FREE

## **E Series Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	550				
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V	0.243			
Q <sub>g</sub> max. (nC)	66				
Q <sub>gs</sub> (nC)	8				
Q <sub>gd</sub> (nC)	14				
Configuration	Single				



#### **FEATURES**

- ullet Low figure-of-merit (FOM)  $R_{on} \times Q_g$
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- Computing
  - PC silver box / ATX power supplies
- Lighting
  - Two stage LED lighting
- Consumer electronics
- · Applications using hard switched topologies
  - Power factor correction (PFC)
  - Two switch forward converter
  - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free and Halogen-free	SiHP15N50E-GE3			

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	$V_{DS}$	500		
Gate-Source Voltage	$V_{GS}$	± 30	V	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $T_C = 25 ^{\circ}C$		14.5	А
	$T_C = 100 ^{\circ}$ C	ID	9.2	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	28	-	
Linear Derating Factor		1.25	W/°C	
Single Pulse Avalanche Energy b	E <sub>AS</sub>	136	mJ	
Maximum Power Dissipation	$P_{D}$	156	W	
Operating Junction and Storage Temperature Rang	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope	$V_{DS} = 0 \text{ V to } 80 \text{ % } V_{DS}$	dV/dt	70	V/ns
Reverse Diode dV/dt <sup>d</sup>	uv/ut	27	] V/IIS	
Soldering Recommendations (Peak Temperature) c for 10 s			300	°C

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 3.1 A.
- c. 1.6 mm from case.
- d.  $I_{SD} \leq I_{D}, \; dI/dt = 100 \; A/\mu s, \; starting \; T_{J} = 25 \; ^{\circ}C.$

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.8	C/VV	

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I <sub>D</sub> = 1 mA		0.62	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
0.1.0	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-Source Leakage			$V_{GS} = \pm 30 \text{ V}$		-	± 1	μΑ
Zava Cata Valtaga Duais Cuurant		V <sub>DS</sub> =	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V		-	10	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 400 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	25	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 7.5 A	-	0.243	0.280	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 7.5 A	-	3.9	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	1162	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 100 \text{ V},$	-	51	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	7	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 400 V, V <sub>GS</sub> = 0 V		-	55	-	pF
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	164	-	
Total Gate Charge	Qg			-	33	66	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 7.5 \text{ A}, V_{DS} = 400 \text{ V}$		8	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				14	-	
Turn-On Delay Time	t <sub>d(on)</sub>			-	15	30	
Rise Time	t <sub>r</sub>	$V_{DD} = 400 \text{ V}, I_D = 12 \text{ A},$		-	24	48	l
Turn-Off Delay Time	t <sub>d(off)</sub>		$V_{DD} = 400 \text{ V, } I_{D} = 12 \text{ A,}$ $V_{GS} = 10 \text{ V, } R_{g} = 9.1 \Omega$		34	68	- ns
Fall Time	t <sub>f</sub>	1			18	36	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.85	-	Ω
<b>Drain-Source Body Diode Characteristic</b>							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14.5	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	28	A
Diode Forward Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 7.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 7.5 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	265	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>			-	3.2	-	μC
Reverse Recovery Current	I <sub>RRM</sub>			-	23	-	A

#### Notes

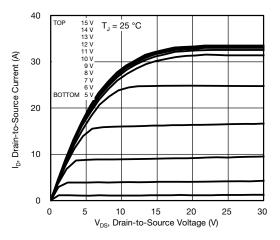
a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



#### SiHP15N50E

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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Fig. 1 - Typical Output Characteristics

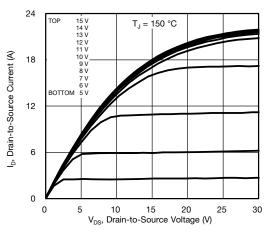


Fig. 2 - Typical Output Characteristics

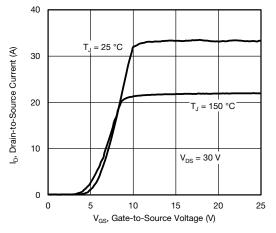


Fig. 3 - Typical Transfer Characteristics

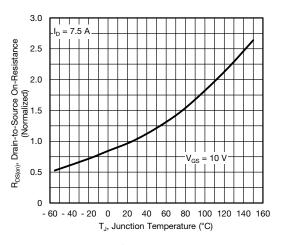


Fig. 4 - Normalized On-Resistance vs. Temperature

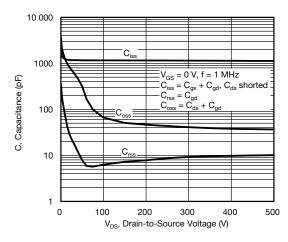


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

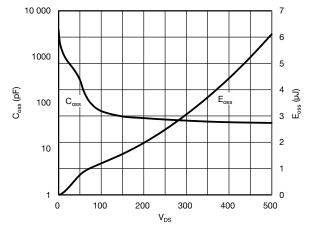


Fig. 6 - Coss and Eoss vs. VDS

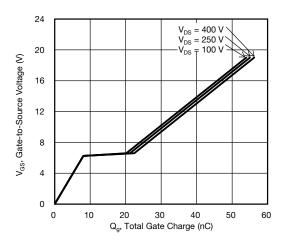
S15-0278-Rev. B, 23-Feb-15 3 Document Number: 91629





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Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

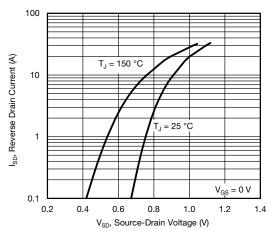


Fig. 8 - Typical Source-Drain Diode Forward Voltage

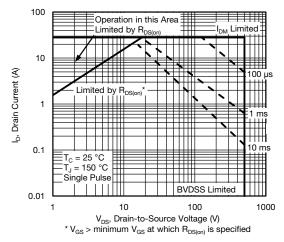


Fig. 9 - Maximum Safe Operating Area

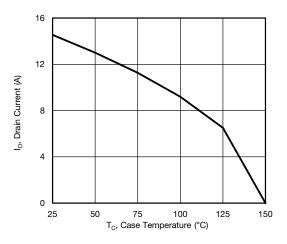


Fig. 10 - Maximum Drain Current vs. Case Temperature

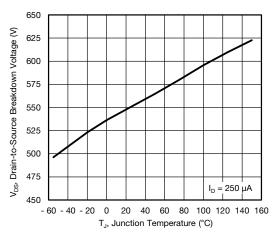


Fig. 11 - Temperature vs. Drain-to-Source Voltage





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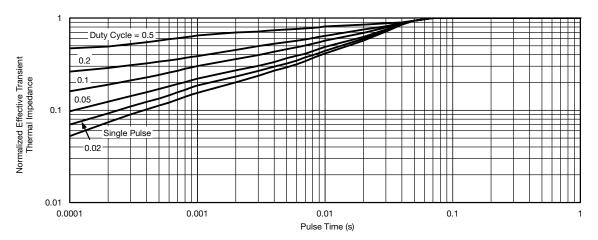


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

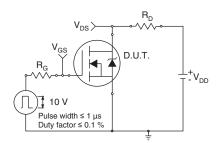


Fig. 13 - Switching Time Test Circuit

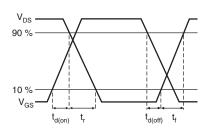


Fig. 14 - Switching Time Waveforms

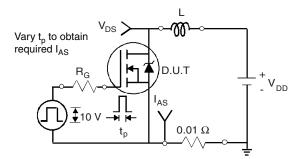


Fig. 15 - Unclamped Inductive Test Circuit

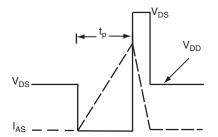


Fig. 16 - Unclamped Inductive Waveforms

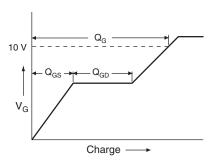


Fig. 17 - Basic Gate Charge Waveform

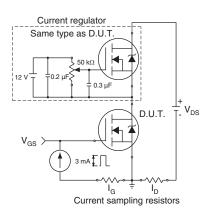


Fig. 18 - Gate Charge Test Circuit

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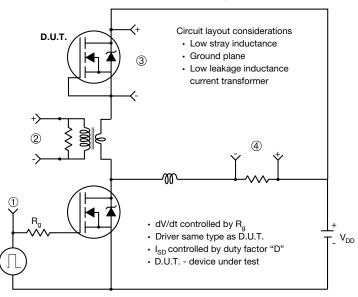
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#### Peak Diode Recovery dV/dt Test Circuit



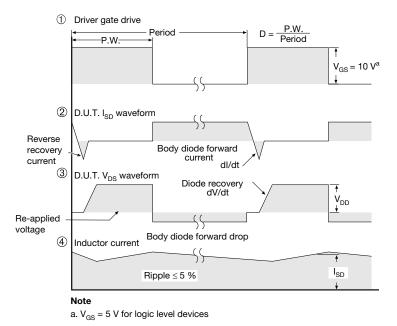


Fig. 19 - For N-Channel

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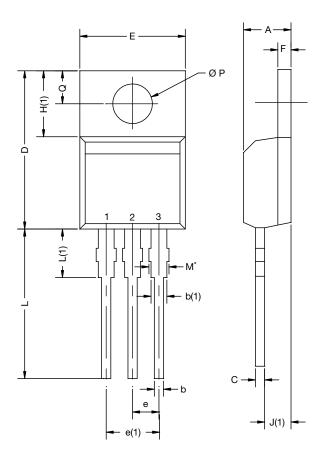




# **Package Information**

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# TO-220-1

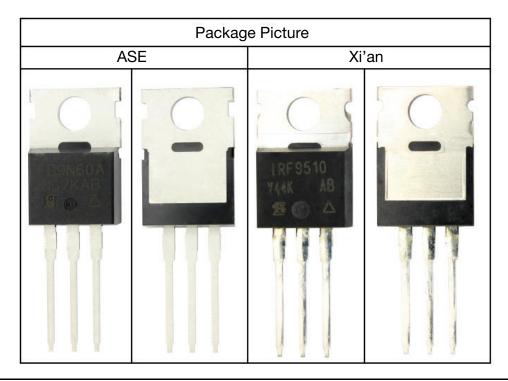


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DIM.	MILLIM	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

#### Note

•  $M^* = 0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 Document Number: 66542



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